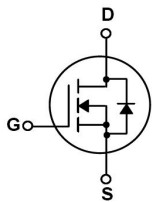


/ Descriptions

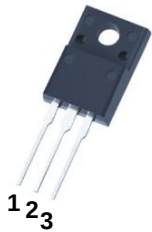
/ Features

/ Applications

/ Equivalent Circuit



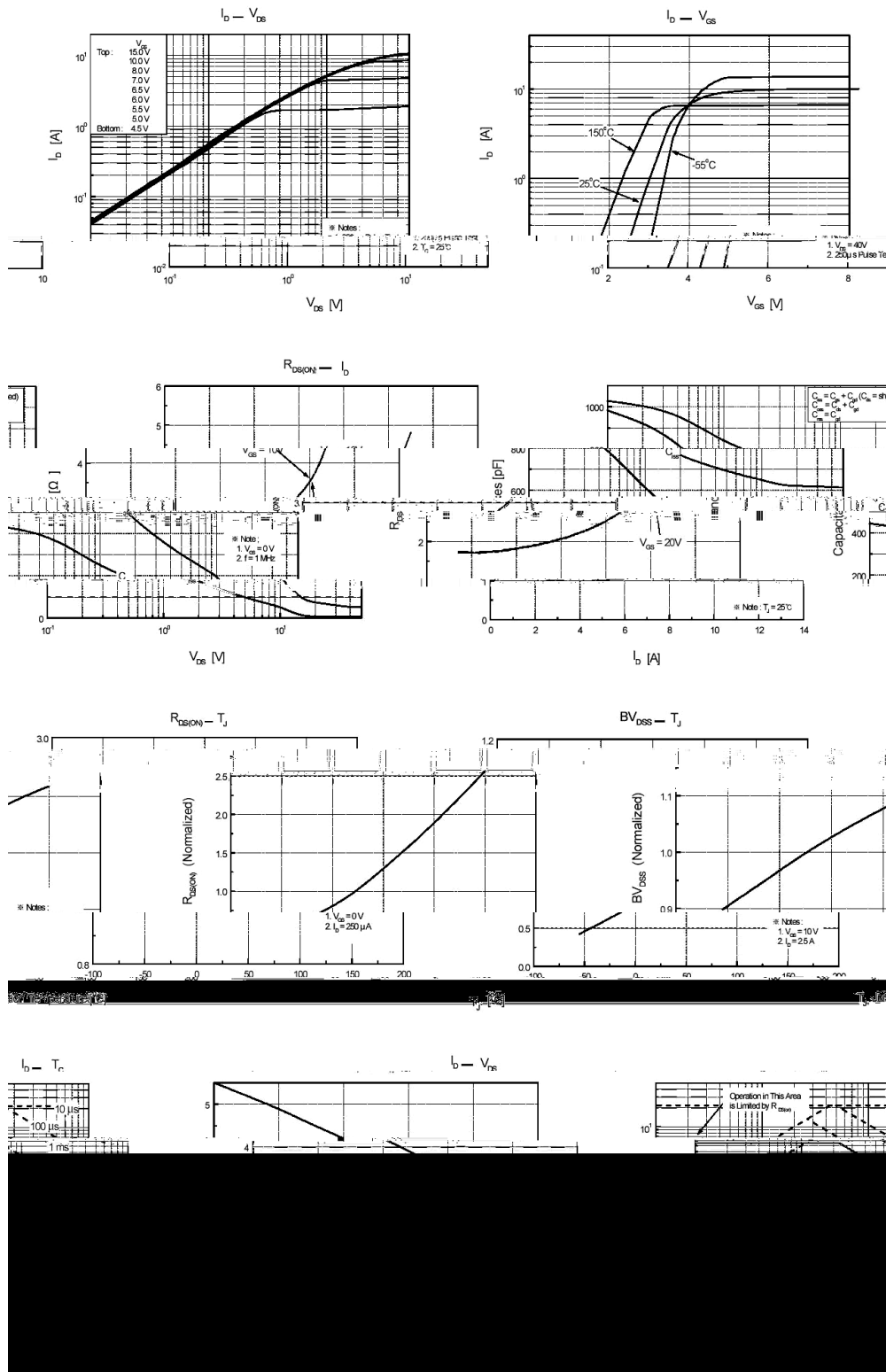
/ Pinning



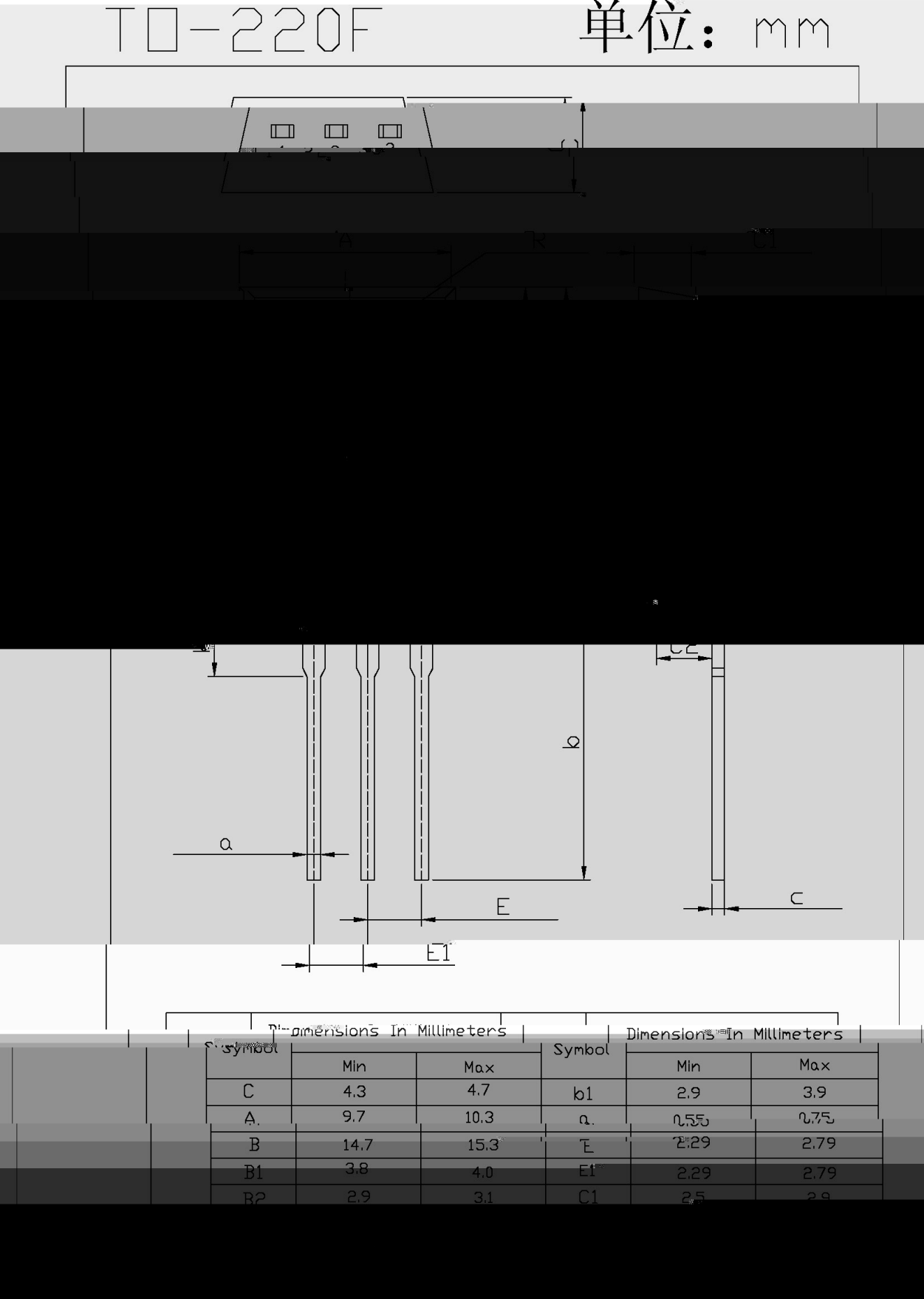
/ h_{FE} Classifications & Marking

[illegible]

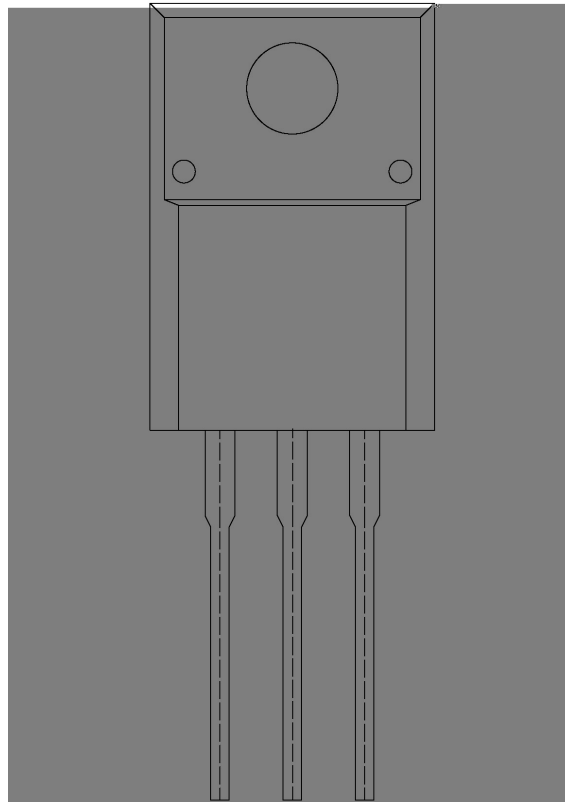
Electrical Characteristic Curve



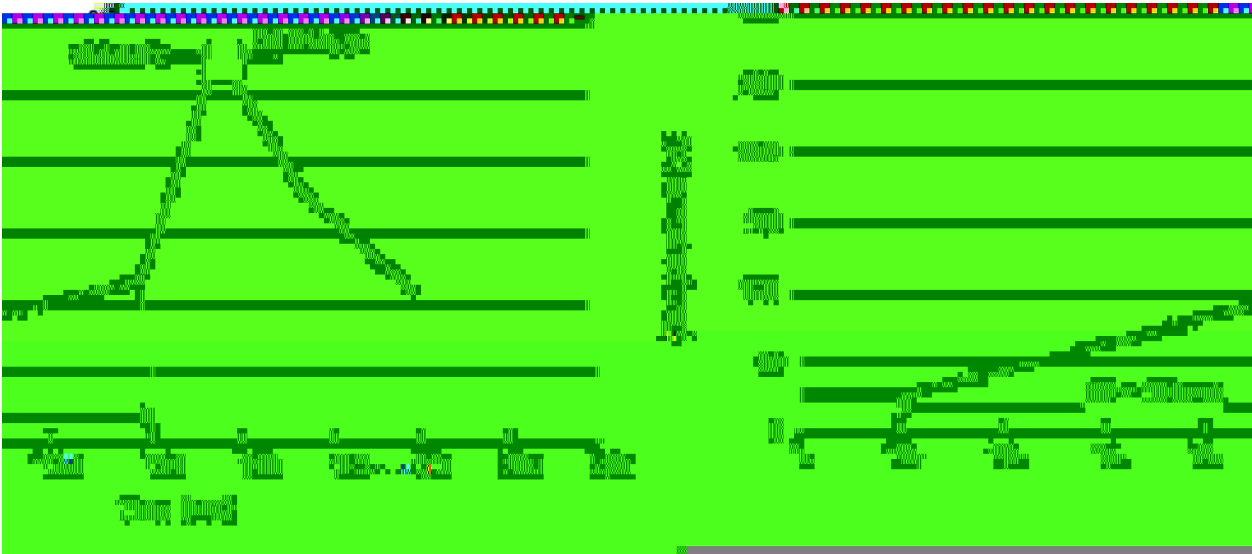
/ Package Dimensions



/ Marking Instructions



() / Temperature Profile for Dip Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

封装形式		包装数量		包装尺寸		:
	只 袋		袋 盒		只 盒	